


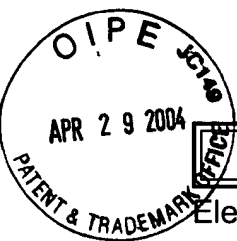


Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
USPTO Use Only


EFS ID: 60087  
Application ID: 10643638   
Title of Invention: BOILING TEMPERATURE DESIGN  
IN PUMPED MICROCHANNEL  
COOLING LOOPS  
First Named Inventor: Peng Zhou  
Domestic/Foreign Application: Domestic Application  
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Confirmation number: 4432  
Attorney Docket Number: NONE

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Trademark Office,ou=Department of Commerce,o=U.S. Government,c=US  
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**TRANSMITTAL**

Electronic Version v1.1  
Stylesheet Version v1.1.0

| <b>Title of<br/>Invention</b>  | <b>BOILING TEMPERATURE DESIGN IN PUMPED MICROCHANNEL<br/>COOLING LOOPS</b> |                |                           |             |                |  |       |            |  |            |
|--|--|----------------|---------------------------|-------------|----------------|--|-------|------------|--|------------|
| Application Number: 10/643638    |  |                |                           |             |                |  |       |            |  |            |
| Date: 2003-08-18   |  |                |                           |             |                |  |       |            |  |            |
| First Named Applicant: Peng Zhou   |  |                |                           |             |                |  |       |            |  |            |
| Confirmation Number: 4432  |  |                |                           |             |                |  |       |            |  |            |
| Attorney Docket Number:  |  |                |                           |             |                |  |       |            |  |            |
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| <table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Thomas B. Haverstock<br/>Registered Number: 32571</td><td>/tbh/</td><td>Attorney</td></tr></tbody></table>   |  |                | Submitted by:             | Elec. Sign. | Sign. Capacity | Thomas B. Haverstock<br>Registered Number: 32571 | /tbh/ | Attorney   |  |            |
| Submitted by:  | Elec. Sign.  | Sign. Capacity |                           |             |                |  |       |            |  |            |
| Thomas B. Haverstock<br>Registered Number: 32571   | /tbh/  | Attorney       |                           |             |                |  |       |            |  |            |
| <table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>COOL01500C-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>   |  |                | Documents being submitted | Files       | us-ids         | COOL01500C-usidst.xml                            |       | us-ids.dtd |  | us-ids.xsl |
| Documents being submitted  | Files  |                |                           |             |                |  |       |            |  |            |
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|  | us-ids.xsl   |                |                           |             |                |  |       |            |  |            |
| <b>Comments</b>  |  |                |                           |             |                |  |       |            |  |            |



## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of  
Invention

BOILING TEMPERATURE DESIGN IN PUMPED  
MICROCHANNEL COOLING LOOPS

Application Number: 10/643638



Confirmation Number: 4432

First Named Applicant: Peng Zhou

Attorney Docket Number:

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or 6101715 or 6119729 or 6126723 or 6129145  
or 6129260 or 6131650 or 6146103 or 6154363  
or 6159353 or 6171067 or 6174675 or 6176962  
or 6186660 or 6210986 or 6216343 or 6221226  
or 6227809 or 6234240 or 6238538 or 6277257  
or 6287440 or 6301109 or 6313992 or 6317326  
or 6321791 or 6322753 or 6324058 or 6351384  
or 6337794 or 6388317 or 6396706 or 6400012  
or 6406605 or 6415860 or 6416642 or 6417060  
or 6424531 or 6443222 or 6444461 or 6457515  
or 6495015 or 6537437 or 6543521 or 6553253  
or 6572749 or 6588498 ).pn.

### US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

| init | Cite.No. | Patent No. | Date       | Patentee          | Kind | Class | Subclass |
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Signature

|               |      |
|---------------|------|
| Examiner Name | Date |
|               |      |